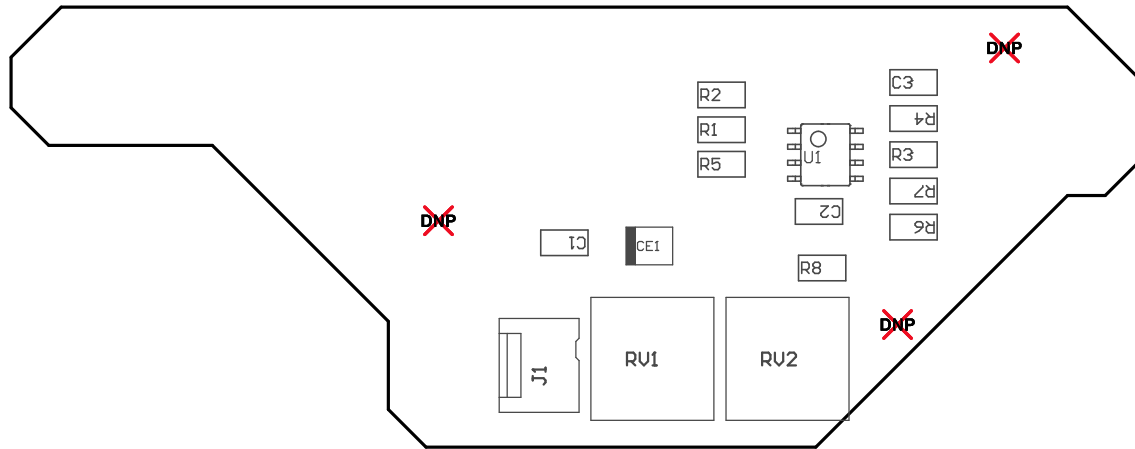
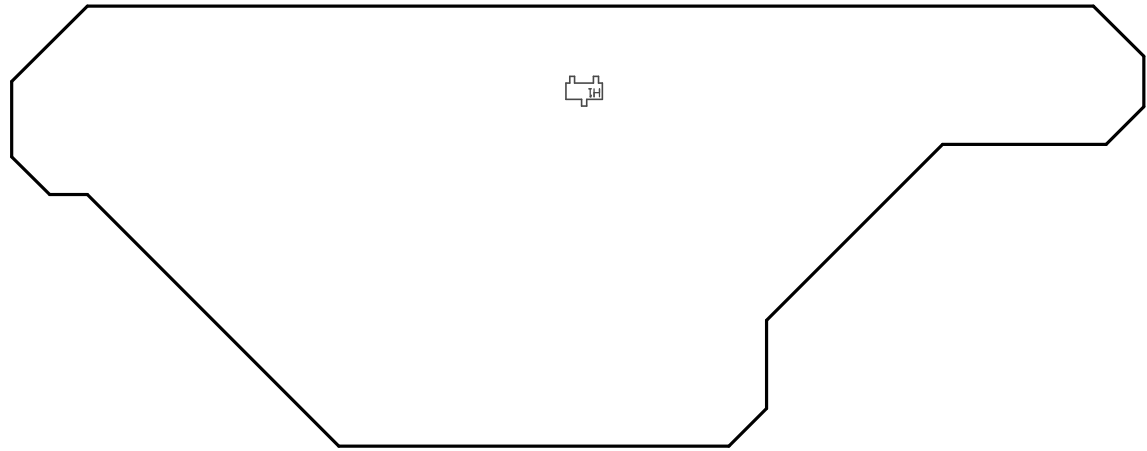


Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
 Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
 Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00642	REV: RevA	SUN REV: Not In VersionControl
	TID #: 00642		
PLOT NAME = Top Assembly Drawing	GENERATED : 11/17/2015	1:22:45 AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00642	REV: RevA	SUN REV: Not In VersionControl
	TID #: 00642		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 11/17/2015 1:22:45 AM	TEXAS INSTRUMENTS	

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